



## DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled <u>MULTILAYER INDUCTOR</u> the specification of which is attached hereto unless the following box is checked:

was filed on February 1 Application Number 09/782		tates Application Number or PC nded on (if a	T International pplicable).	
I hereby state that I have reviewed claims, as amended by any amendr		of the above identified specifica	tion, including the	
I acknowledge the duty to disclose	information which is materia	al to patentability as defined in 3	7 CFR § 1.56.	
I hereby claim foreign priority ben or inventor's certificate, or § 365(a than the United States, listed below certificate, or PCT International ap claimed.	a) of any PCT International ap w and have also identified bel	oplication which designated at le ow any foreign application for p	east one country other atent or inventor's	
Prior Foreign Application(s)		Priority Date	Priority Claimed	
2000-035593	JAPAN	February 14, 2000	Yes No	
(Number)	(Country) (PCT)	(Day/Month/Year Filed)		
I hereby claim the benefit under 35  (Application Number)	U.S.C. § 119(e) of any Unit	ed States provisional application (Filing Date)	n(s) listed below.	
(Application Number)		(Filing Date)		
I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.				
(Application Number)	(Filing Date)	(Status – patente	(Status – patented, pending, abandoned)	

(Ann	lication	Num	ber)
14100	IIOMEIOII	1 4 00 1 1 1	~~,

(Filing Date)

(Status - patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor (given name, family name)	Kejii SAKATA
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